



TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	CLK_SEL	Input	Pullup	Clock select input. Selects LVCMOS clock input when HIGH. Selects CLK, nCLK inputs when LOW. LVCMOS / LVTTTL interface levels.
2	LVCMOS_CLK	Input	Pullup	Clock input. LVCMOS / LVTTTL interface levels.
3	CLK	Input	Pullup	Non-inverting differential clock input.
4	nCLK	Input	Pulldown	Inverting differential clock input.
5	CLK_EN	Input	Pullup	Clock enable. LVCMOS / LVTTTL interface levels.
6	OE	Input	Pullup	Output enable. LVCMOS / LVTTTL interface levels.
7	V _{DD}	Power		Positive supply pin.
8, 12, 16, 20, 24, 28, 32	GND	Power		Power supply ground.
9, 11, 13, 15, 17, 19, 21, 23 25, 27, 29, 31	Q11, Q10, Q9, Q8, Q7, Q6, Q5, Q4, Q3, Q2, Q1, Q0	Output		Clock outputs. LVCMOS / LVTTTL interface levels.
10, 14, 18, 22, 26, 30	V _{DDO}	Power		Output supply pins.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
C _{PD}	Power Dissipation Capacitance (per output)			25		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
R _{OUT}	Output Impedance			7		Ω

TABLE 3A. CLOCK SELECT FUNCTION TABLE

Control Input	Clock	
CLK_SEL	CLK, nCLK	LVCMOS_CLK
0	Selected	De-selected
1	De-selected	Selected

TABLE 3B. CLOCK INPUT FUNCTION TABLE

Inputs				Outputs	Input to Output Mode	Polarity
CLK_SEL	LVCMOS_CLK	CLK	nCLK	Q0:Q12		
0	—	0	1	LOW	Differential to Single Ended	Non Inverting
0	—	1	0	HIGH	Differential to Single Ended	Non Inverting
0	—	0	Biased; NOTE 1	LOW	Single Ended to Single Ended	Non Inverting
0	—	1	Biased; NOTE 1	HIGH	Single Ended to Single Ended	Non Inverting
0	—	Biased; NOTE 1	0	HIGH	Single Ended to Single Ended	Inverting
0	—	Biased; NOTE 1	1	LOW	Single Ended to Single Ended	Inverting
1	0	—	—	LOW	Single Ended to Single Ended	Non Inverting
1	1	—	—	HIGH	Single Ended to Single Ended	Non Inverting

NOTE 1: Please refer to the Application Information section, "Wiring the Differential Input to Accept Single Ended Levels".



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to $V_{DD} + 0.5$ V
Outputs, V_O	-0.5V to $V_{DDO} + 0.5$ V
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 0.3V$, $T_A = -40^\circ$ TO 85°

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Positive Supply Voltage		3.0	3.3	3.6	V
V_{DDO}	Output Supply Voltage		3.0	3.3	3.6	V
I_{DD}	Power Supply Current				55	mA

TABLE 4B. DC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 0.3V$, $T_A = -40^\circ$ TO 85°

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		2		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage		-0.3		0.8	V
V_{PP}	Peak-to-Peak Input Voltage		0.15		1.3	V
V_{CMR}	Input Common Mode Voltage; NOTE 1, 2		GND + 0.5		$V_{DD} - 0.85$	V
I_{IN}	Input Current				± 100	μA
V_{OH}	Output High Voltage	$I_{OH} = -20mA$	2.5			V
V_{OL}	Output Low Voltage	$I_{OL} = 20mA$			0.4	V

NOTE 1: For single ended applications, the maximum input voltage for CLK, nCLK is $V_{DD} + 0.3V$.

NOTE 2: Common mode voltage is defined as V_{IH} .



TABLE 5. AC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 0.3V$, $T_A = -40^\circ$ TO 85°

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency					250	MHz
t_{PD}	Propagation Delay	CLK, nCLK; NOTE 1A	$f \leq 150\text{MHz}$	2.25		3.75	ns
		LVC MOS_CLK; NOTE 1B	$f \leq 150\text{MHz}$	2		4	ns
$tsk(o)$	Output Skew; NOTE 2, 6		Measured on rising edge @ $V_{DDO}/2$			350	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 6	CLK, nCLK	Measured on rising edge @ $V_{DDO}/2$			1.5	ns
		LVC MOS_CLK				2	ns
t_R	Output Rise Time		0.8V to 2V	0.2		1.0	ns
t_F	Output Fall Time		0.8V to 2V	0.2		1.0	ns
t_{PW}	Output Pulse Width		$f < 150\text{MHz}$	$t_{Cycle}/2 - 800$		$t_{Cycle}/2 + 800$	ps
t_{PZL}, t_{PZH}	Output Disable Time; NOTE 4					11	ns
t_{PLZ}, t_{PHZ}	Output Enable Time; NOTE 4					11	ns
t_S	Clock Enable Setup Time; NOTE 5	CLK_EN to CLK, nCLK		1			ns
		CLK_EN to LVC MOS_CLK		0			ns
t_H	Clock Enable Hold Time; NOTE 5	CLK, nCLK to CLK_EN		1			ns
		LVC MOS_CLK to CLK_EN		1			ns

NOTE 1A: Measured from the differential input crossing point to $V_{DDO}/2$ of the output.

NOTE 1B: Measured from the $V_{DD}/2$ or crosspoint of the input to $V_{DDO}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured at $V_{DDO}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDO}/2$.

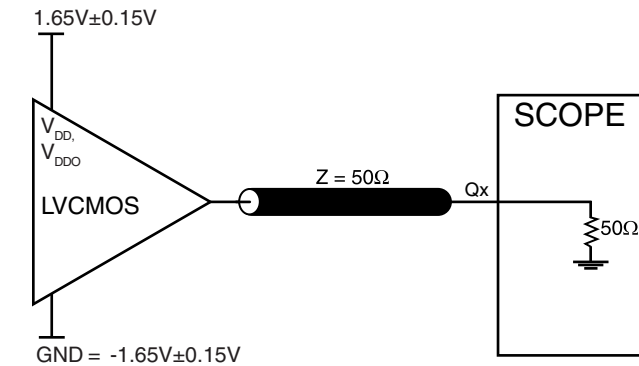
NOTE 4: These parameters are guaranteed by characterization. Not tested in production.

NOTE 5: Setup and Hold times are relative to the rising edge of the input clock.

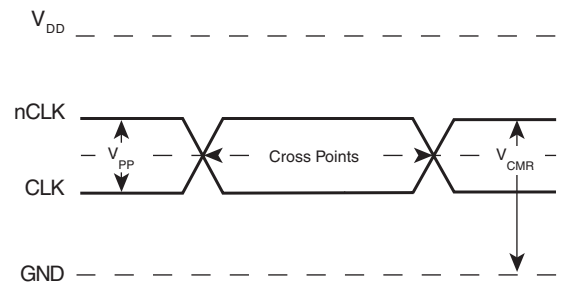
NOTE 6: This parameter is defined in accordance with JEDEC Standard 65.



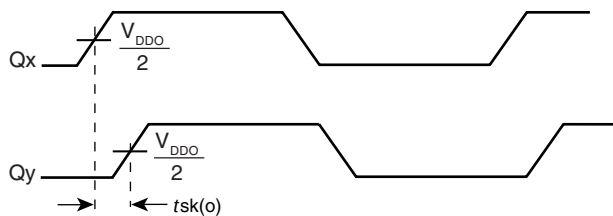
PARAMETER MEASUREMENT INFORMATION



3.3V OUTPUT LOAD AC TEST CIRCUIT



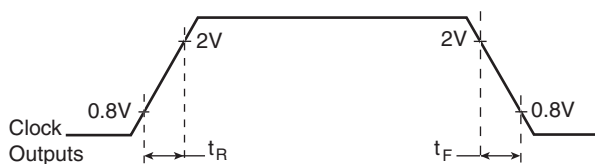
DIFFERENTIAL INPUT LEVEL



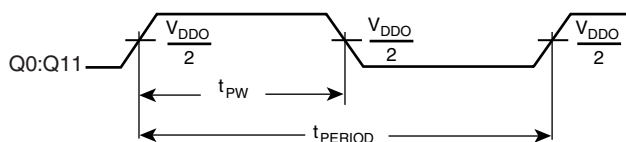
OUTPUT SKEW



PART-TO-PART SKEW

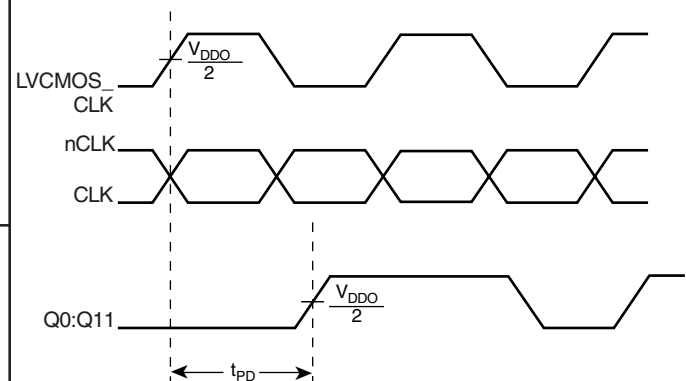


OUTPUT RISE/FALL TIME



$$odc = \frac{t_{PW}}{t_{PERIOD}}$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



PROPAGATION DELAY

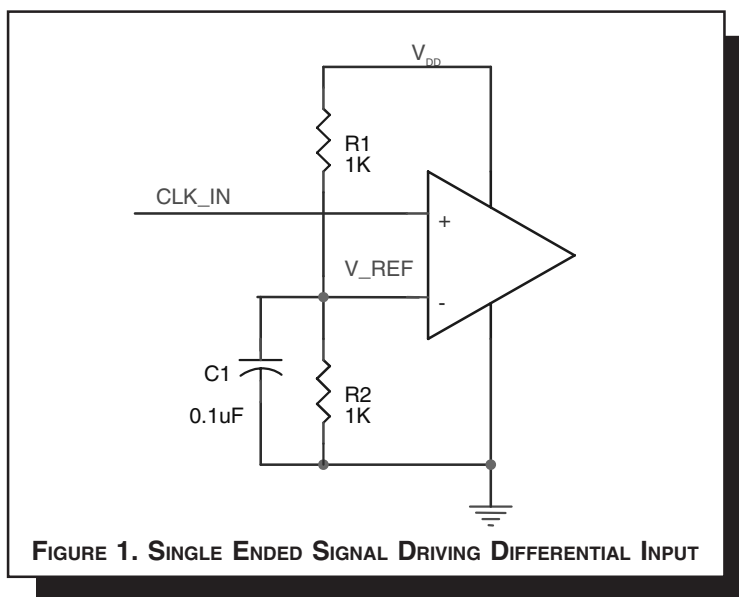


APPLICATION INFORMATION

WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 1 shows how the differential input can be wired to accept single ended levels. The reference voltage $V_{REF} = V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio

of R1 and R2 might need to be adjusted to position the V_{REF} in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3V$, V_{REF} should be 1.25V and $R2/R1 = 0.609$.



RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

CLK INPUT:

For applications not requiring the use of a clock input, it can be left floating. Though not required, but for additional protection, a 1k Ω resistor can be tied from the CLK input to ground.

CLK/nCLK INPUT:

For applications not requiring the use of the differential input, both CLK and nCLK can be left floating. Though not required, but for additional protection, a 1k Ω resistor can be tied from CLK to ground.

LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1k Ω resistor can be used.

OUTPUTS:

LVCMOS OUTPUT:

All unused LVCMOS output can be left floating. We recommend that there is no trace attached.



RELIABILITY INFORMATION

TABLE 6. θ_{JA} VS. AIR FLOW TABLE FOR 32 LEAD LQFP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS83948I is: 1040

Pin compatible with the MPC948/948L



PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

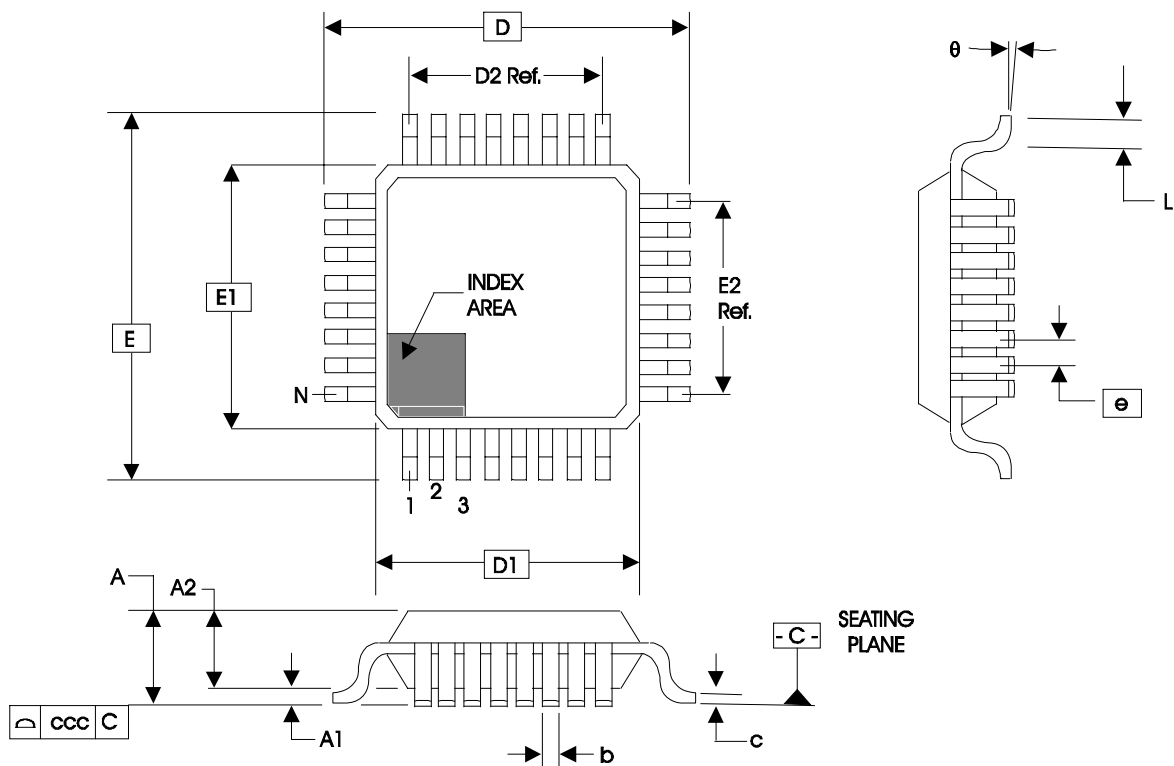


TABLE 7. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N	32		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.60 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.60 Ref.		
e	0.80 BASIC		
L	0.45	0.60	0.75
theta	0°	--	7°
ccc	--	--	0.10

REFERENCE DOCUMENT: JEDEC PUBLICATION 95, MS-026



Integrated
Circuit
Systems, Inc.

ICS83948I

LOW SKEW, 1-TO-12

DIFFERENTIAL-TO-LVCMOS FANOUT BUFFER

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS83948AYI	ICS83948AYI	32 Lead LQFP	tray	0°C to 70°C
ICS83948AYIT	ICS83948AYI	32 Lead LQFP	1000 tape & reel	0°C to 70°C
ICS83948AYILF	ICS83948AYIL	32 Lead "Lead-Free" LQFP	tray	0°C to 70°C
ICS83948AYILFT	ICS83948AYIL	32 Lead "Lead-Free" LQFP	1000 tape & reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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REVISION HISTORY SHEET				
Rev	Table	Page	Description of Change	Date
B	T5	4	AC Characteristics table - t_{LZ} , t_{HZ} row changed symbol to read t_{PLZ} , t_{PHZ} and changed Parameter to read Output Enable Time. Added rows: t_S "Clock Enable Setup Time" and t_H "Clock Enable Hold Time".	05/20/02
B	T5	4	AC Characteristics table, t_S and t_H rows - replaced SYNC_OE with CLK_EN. Added an extra note to Propagation Delay row.	6/26/02
B	T5	4	AC Characteristics table, f_{MAX} row corrected typo error of 150MHz to 250MHz.	8/8/02
B	T5	4	AC Characteristics table - tPW row, added $f < 150\text{MHz}$ for tPW Test Conditions.	11/11/02
C	T2	1	Features Section - added Lead-Free bullet.	12/15/05
		2	Pin Characteristics Table - changed C_{IN} from 4pF max. to 4pF typical.	
		6	Added <i>Recommendations for Unused Output Pins</i> .	
	T8	9	Ordering Information Table - added Lead-Free part number, marking and note.	